

## N-Channel Super Junction Power MOSFET IV

### General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

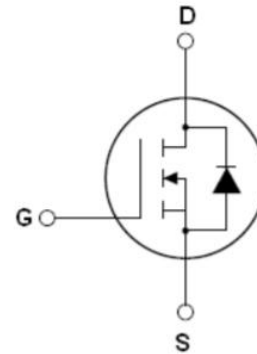
### Features

- Optimized body diode reverse recovery performance
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

$V_{DS\ min@T_{jmax}}$	650	V
$R_{DS(ON)TYP.}$	880	m $\Omega$
$I_D$	4.3	A
$Q_g$	8.5	nC



Schematic diagram

### Package Marking And Ordering Information

Device	Device Package	Marking
NCE60N1K0R	SOT-223-2L	NCE60N1K0R



SOT-223-2L

Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Drain-Source Voltage ( $V_{GS}=0V$ )	$V_{DS}$	600	V
Gate-Source Voltage ( $V_{DS}=0V$ ), AC ( $f>1\text{ Hz}$ )	$V_{GS}$	$\pm 30$	V
Gate-Source Voltage ( $V_{DS}=0V$ ), DC	$V_{GS}$	$\pm 20$	V
Continuous Drain Current at $T_c=25^\circ\text{C}$	$I_{D(DC)}$	4.3	A
Continuous Drain Current at $T_c=100^\circ\text{C}$	$I_{D(DC)}$	3.0	A
Pulsed drain current (Note 1)	$I_{DM(pluse)}$	12.9	A
Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )	$P_D$	5.3	W
Derate above $25^\circ\text{C}$		0.035	W/ $^\circ\text{C}$
Single pulse avalanche current (Note 2)	$I_{AS}$	1	A
Repetitive Avalanche energy, $t_{AR}$ limited by $T_{jmax}$ (Note 1)	$E_{AR}$	0.9	mJ
Reverse diode dv/dt, $V_{DS} \leq 480\text{ V}, I_{SD} < I_D$	dv/dt	15	V/ns
Drain Source voltage slope, $V_{DS} \leq 480\text{ V}$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55...+175	$^\circ\text{C}$

**Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	$R_{thJC}$	28.3	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient (Maximum)	$R_{thJA}$	62	$^{\circ}\text{C}/\text{W}$

**Table 3. Electrical Characteristics (TA=25 $^{\circ}\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>On/off states</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	600			V
Zero Gate Voltage Drain Current(Tc=25 $^{\circ}\text{C}$ )	$I_{DSS}$	$V_{DS}=600V, V_{GS}=0V$			1	$\mu A$
Zero Gate Voltage Drain Current(Tc=125 $^{\circ}\text{C}$ )	$I_{DSS}$	$V_{DS}=600V, V_{GS}=0V$			50	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 200$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	3		4	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=2A$		880	1000	m $\Omega$
<b>Dynamic Characteristics</b>						
Gate Resistance	$R_g$	F=1MHZ, D-S short		40		$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=50V, V_{GS}=0V,$ F=1MHz		252		pF
Output Capacitance	$C_{oss}$			1.82		pF
Reverse Transfer Capacitance	$C_{rss}$			0.78		pF
Total Gate Charge	$Q_g$	$V_{DS}=400V, I_D=2A,$ $V_{GS}=10V$		8.5	10.5	nC
Gate-Source Charge	$Q_{gs}$			1.6		nC
Gate-Drain Charge	$Q_{gd}$			3		nC
Gate plateau voltage	$V_{gp}$			4.8		V
<b>Switching times</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=380V, I_D=2A,$ $R_G=4\Omega, V_{GS}=10V$		8		nS
Turn-on Rise Time	$t_r$			10		nS
Turn-Off Delay Time	$t_{d(off)}$			18		nS
Turn-Off Fall Time	$t_f$			15		nS
<b>Source- Drain Diode Characteristics</b>						
Source-drain current(Body Diode)	$I_{SD}$	$T_C=25^{\circ}\text{C}$			4.3	A
Pulsed-Source-drain current(Body Diode)	$I_{SDM}$				12.9	A
Forward on voltage	$V_{SD}$	$T_j=25^{\circ}\text{C}, I_{SD}=4.3A, V_{GS}=0V$		0.9	1.1	V
Reverse Recovery Time	$t_{rr}$	$T_j=25^{\circ}\text{C}, I_F=2A,$ $di/dt=100A/\mu s$		150		nS
Reverse Recovery Charge	$Q_{rr}$			0.87		$\mu C$
Peak reverse recovery current	$I_{rm}$			11.6		A

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2.  $T_j=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

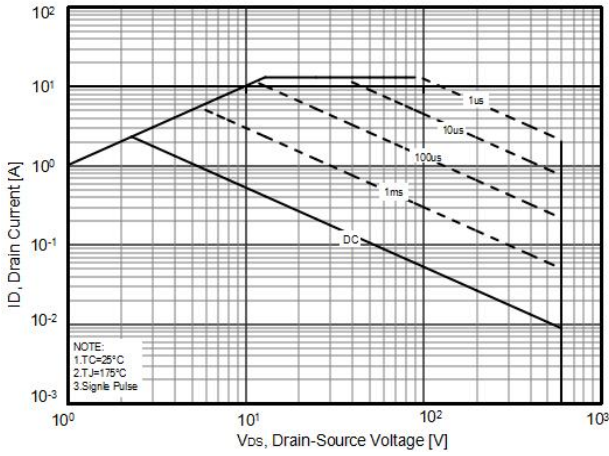


Figure2. Source-Drain Diode Forward Voltage

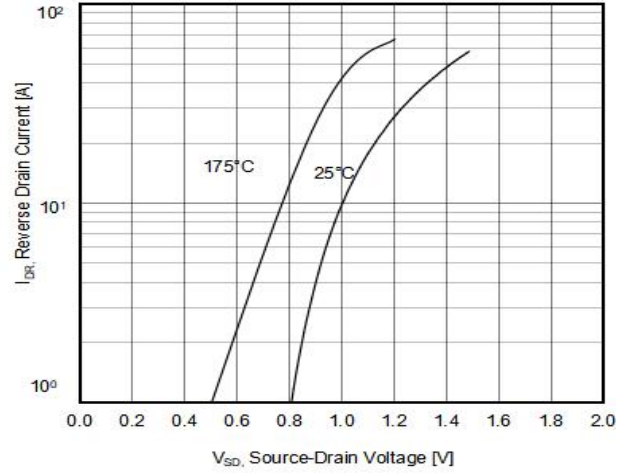


Figure3. Transfer characteristics

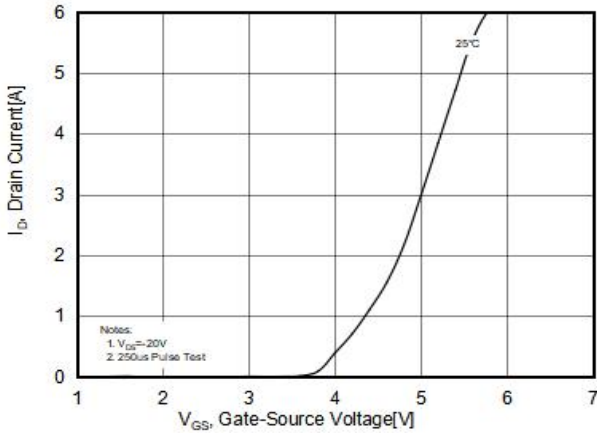


Figure4. Output characteristics

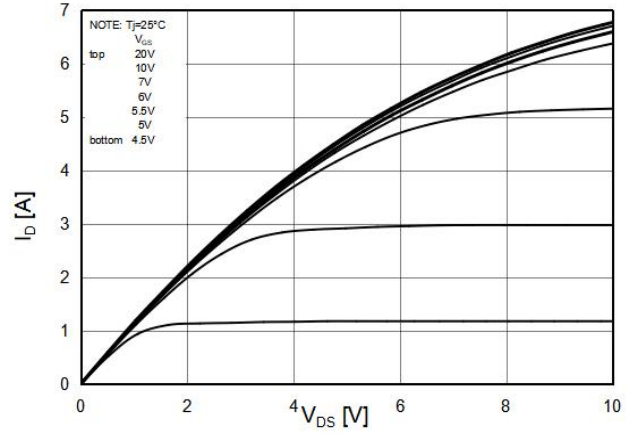


Figure5. Static drain-source on resistance

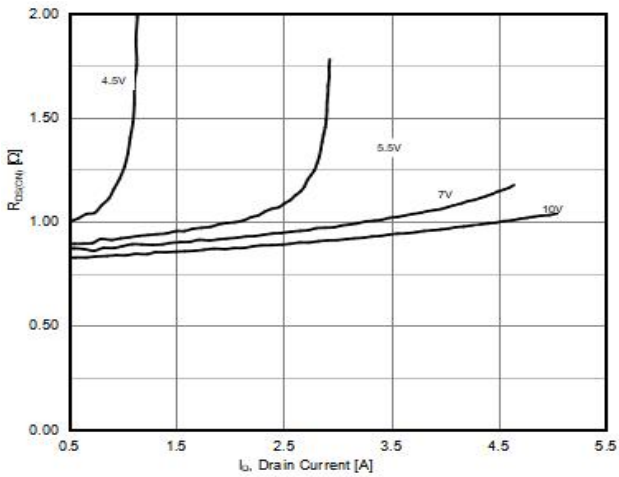
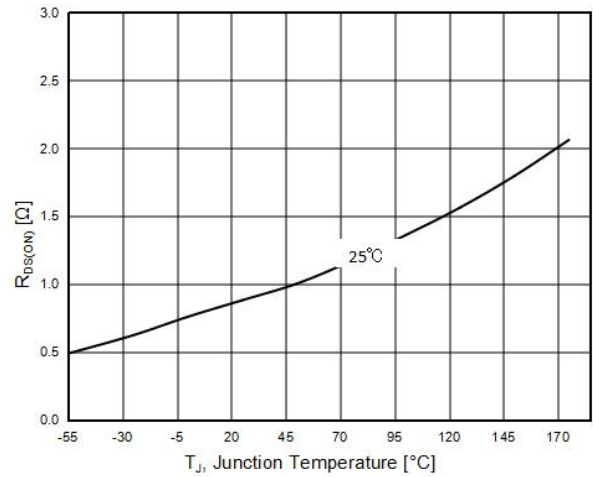
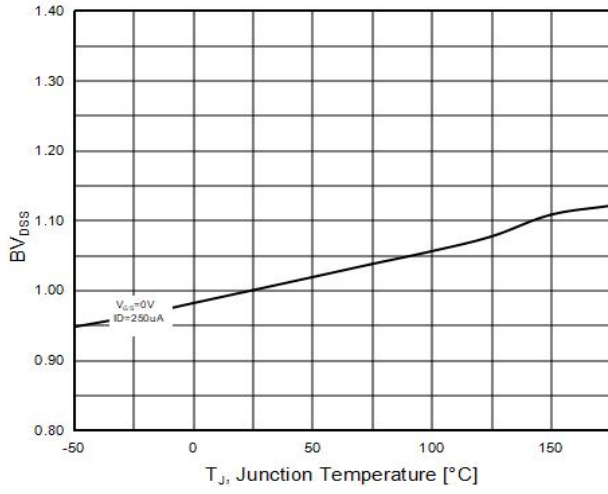


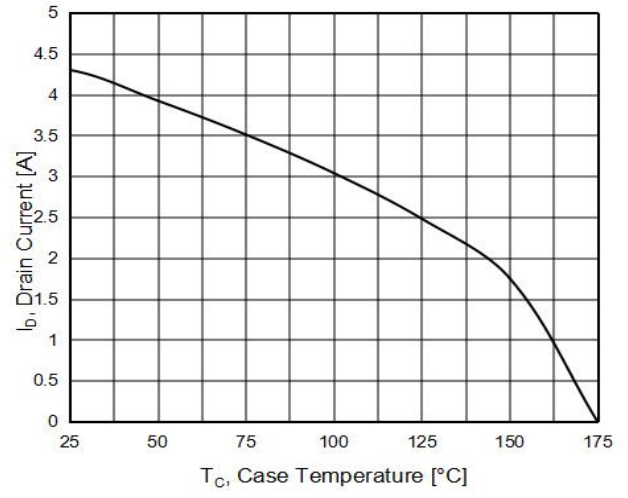
Figure6.  $R_{DS(ON)}$  vs Junction Temperature



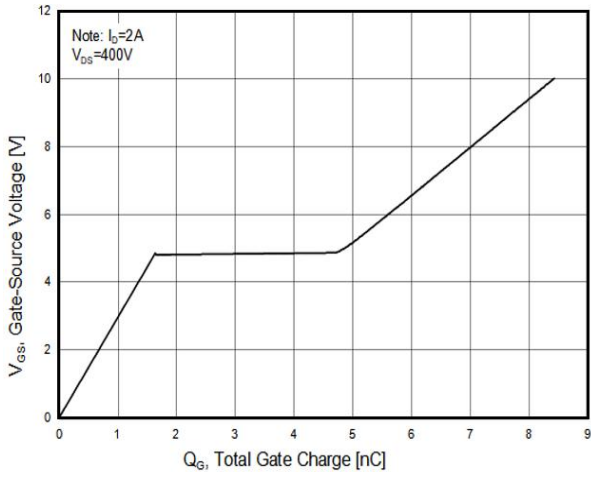
**Figure7.  $BV_{DSS}$  vs Junction Temperature**



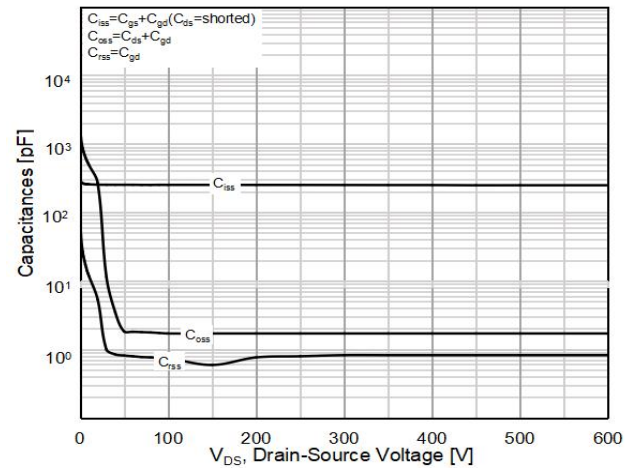
**Figure8. Maximum  $I_D$  vs Junction Temperature**



**Figure9. Gate charge waveforms**



**Figure10. Capacitance**



## Test circuit

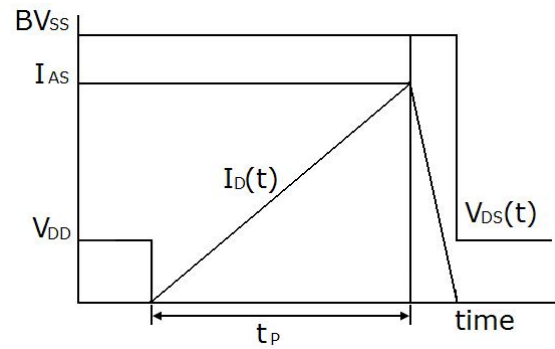
### 1) Gate charge test circuit & Waveform



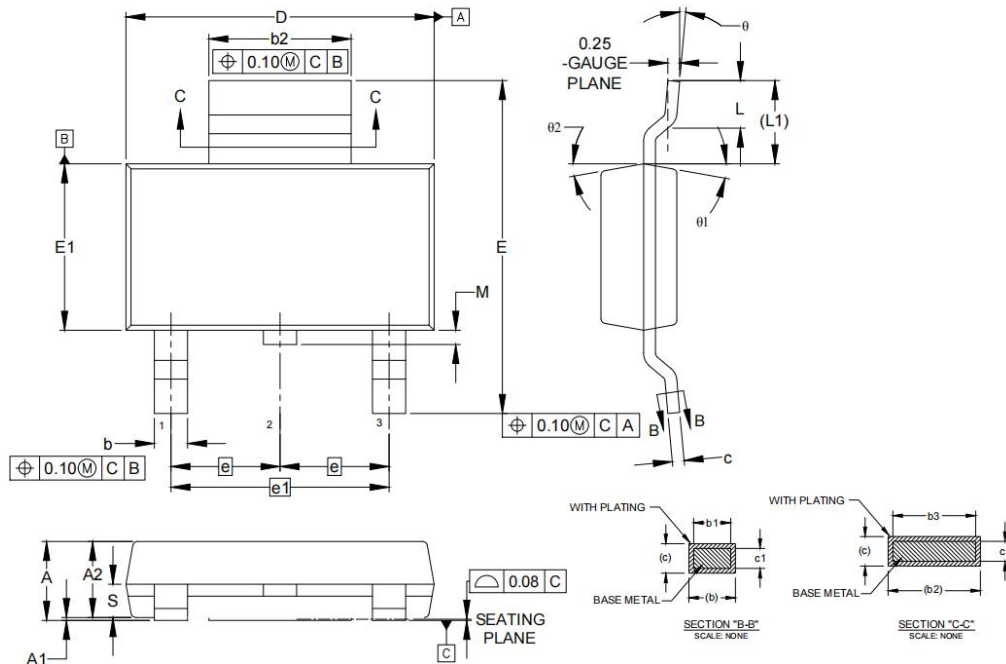
### 2) Switch Time Test Circuit:



### 3) Unclamped Inductive Switching Test Circuit & Waveforms



## SOT-223-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.52	1.80	0.060	0.071
A1	0.02	0.10	0.001	0.004
A2	1.50	1.70	0.059	0.067
b	0.60	0.80	0.024	0.031
b1	0.60	0.78	0.024	0.031
b2	2.95	3.10	0.116	0.122
b3	2.95	3.05	0.116	0.120
c	0.24	0.32	0.009	0.013
c1	0.24	0.30	0.009	0.012
D	6.30	6.70	0.248	0.264
E	6.70	7.30	0.264	0.287
E1	3.30	3.70	0.130	0.146
e	2.30 BSC.		0.091 BSC.	
e1	4.60 BSC.		0.182 BSC.	
L	0.90	1.10	0.035	0.043
L1	1.75 REF		0.069 REF	
M	---	0.50	---	0.020
S	0.70 REF		0.028 REF	
θ	0°	10°	0°	10°
θ1	10° REF		10° REF	
θ2	10° REF		10° REF	

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